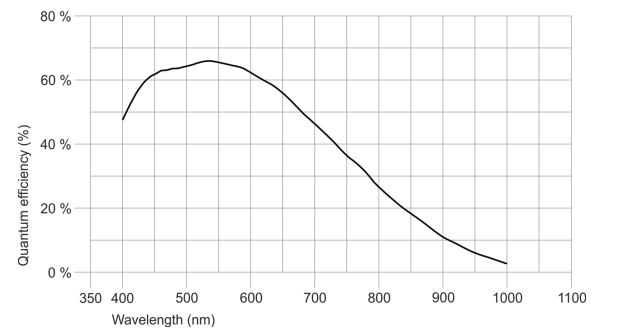


Not recommended for new designs
The camera model is no longer recommended for new application development.



Specification

Sensor	
Sensor type	CMOS Mono
Shutter	Global Shutter
Sensor characteristic	Linear
Pixel Class	9 MP
Resolution	8.92 Mpix
Resolution (h x v)	4104 x 2174 Pixel
Aspect ratio	17:9
ADC	12 bit
Color depth (camera)	12 bit
Optical sensor class	1"
Optical Size	14.159 mm x 7.500 mm
Optical sensor diagonal	16.02 mm 1"
Pixel size	3.45 µm
CRA (Chief Ray Angle)	0 °
Manufacturer	Sony
Sensor Model	IMX267LLR-C
Gain (master/RGB)	24x/4x
AOI horizontal	same frame rate
AOI vertical	increased frame rate
AOI image width / step width	256 / 8
AOI image height / step width	2 / 2
AOI position grid (horizontal/vertical)	4 / 2
Binning horizontal	increased frame rate
Binning vertical	increased frame rate
Binning method	Horizontal: addition / Vertical: addition
Binning factor	2
Decimation (subsampling) horizontal	same frame rate
Decimation (subsampling) vertical	increased frame rate
Decimation (subsampling) method	M/C automatic



Model

Pixel clock range	99 MHz - 140 MHz
Frame rate freerun mode	12 fps
Frame rate trigger (continuous)	12 fps
Frame rate trigger (maximum)	12 fps
Exposure time (minimum - maximum)	0.047 ms - 1000 ms
Long exposure (maximum)	30000 ms
Power consumption	1.7 W - 3.1 W
Image memory	128 MB
Special features	IDS line scan mode Overlap trigger Sensor source gain

Ambient conditions

The temperature values given below refer to the outer device temperature of the camera housing.

Allowed device temperature during operation	0 °C - 55 °C / 32 °F - 131 °F
Allowed ambient temperature during storage	-20 °C - 60 °C / -4 °F - 140 °F
Humidity (relative, non-condensing)	20 % - 80 %

Connectors

Interface connector	GigE RJ45, screwable
I/O connector	8-pin Hirose connector (HR25-7TR-8PA(73))
Power supply	12 V - 24 V or PoE

Pin assignment I/O connector

1	Ground (GND)
2	Flash output with optocoupler (-)
3	General Purpose I/O (GPIO) 1
4	Trigger input with optocoupler (-)
5	Flash output with optocoupler (+)
6	General Purpose I/O (GPIO) 2
7	Trigger input with optocoupler (+)
8	Input power supply (VCC) 12-24 V DC



Design

Lens Mount	C-Mount
IP code	IP30
Dimensions H/W/L	34.0 mm x 44.0 mm x 47.0 mm
Mass	107 g
Housing material	Aluminum

Features

List of on-camera image pre-processing features.

All features of the table are available via our IDS peak software for image pre-processing on the host computer (sensor model dependent).

Image Acquisition

Freerun	✓
Software trigger	-
Hardware trigger	✓
Trigger controlled exposure	-
Denoiser	-
Long exposure	✓
Line scan	✓

UI-5290SE-M-GL Rev.4.2 (AB12265)

Flashing	Flashing	-
	PWM flashing	-
Image Adjustments	Auto exposure	-
	Auto gain	-
	Auto whitebalance	-
	Color correction	-
	Gamma	-
	LUT	-
On-board Image Processing	Mirror/flip	-
	Pixel formats	
	Region of interest	✓
	Decimation (FPGA)	-
	Decimation (Sensor)	(2,4)x(2,4)
	Binning (FPGA)	-
Others	Chunks	-
	Sequencer	-
	Firmware update	-
	1st supported firmware version	4.96.1